TEXAS INSTRUMENTS

10UT [

1IN- 🛛 2

1IN+ 🛛 3

V<sub>CC</sub> [] 4

2IN+ 🛛 5

2IN- 🚺 6

20UT [

1

7

D, N, OR PW PACKAGE

(TOP VIEW)

14 40UT

13 4IN-

10 3IN+

GND

1 30UT

12 4IN+

11

9 3IN-

8

### FEATURES

- Low Supply Current . . . 85 μA Typ
- Low Offset Voltage . . . 2 mV Typ
- Low Input Bias Current . . . 2 nA Typ
- Input Common Mode to GND
- Wide Supply Voltage . . . 3 V < V<sub>CC</sub> < 32 V
- Pin Compatible With LM324
- Applications
  - LCD Displays
  - Portable Instrumentation
  - Sensor/Metering Equipment
  - Consumer Electronics (MP3 Players, Toys, Etc.)
  - Power Supplies

## **DESCRIPTION/ORDERING INFORMATION**

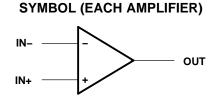
The LP324 and LP2902 are quadruple low-power operational amplifiers especially suited for battery-operated applications. Good input specifications and wide supply-voltage range still are achieved, despite the ultra-low supply current. Single-supply operation is achieved with an input common-mode range that includes GND.

The LP324 and LP2902 are ideal in applications where wide supply voltage and low power are more important than speed and bandwidth. These applications include portable instrumentation, LCD displays, consumer electronics (MP3 players, toys, etc.), and power supplies.

| T <sub>A</sub> | P          | ACKAGE <sup>(1)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |  |  |
|----------------|------------|-----------------------|-----------------------|------------------|--|--|
|                | PDIP – N   | Tube of 25            | LP324N                | LP324N           |  |  |
|                | SOIC – D   | Tube of 50            | LP324D                | LP324            |  |  |
| 0°C to 70°C    | 50IC - D   | Reel of 2500          | LP324DR               | - LP324          |  |  |
|                | TSSOP – PW | Tube of 90            | LP324PW               | LP324            |  |  |
|                | 1330P - PW | Reel of 2000          | LP324PWR              | - LP324          |  |  |
|                | PDIP – N   | Tube of 25            | LP2902N               | LP2902N          |  |  |
|                | SOIC – D   | Tube of 50            | LP2902D               | LP2902           |  |  |
| –40°C to 85°C  | 50IC - D   | Reel of 2500          | LP2902DR              | LP2902           |  |  |
|                | TSSOP – PW | Tube of 50            | LP2902PW              | 1 02002          |  |  |
|                | 13306 - 80 | Reel of 2500          | LP2902PWR             | - LP2902         |  |  |

### ORDERING INFORMATION

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



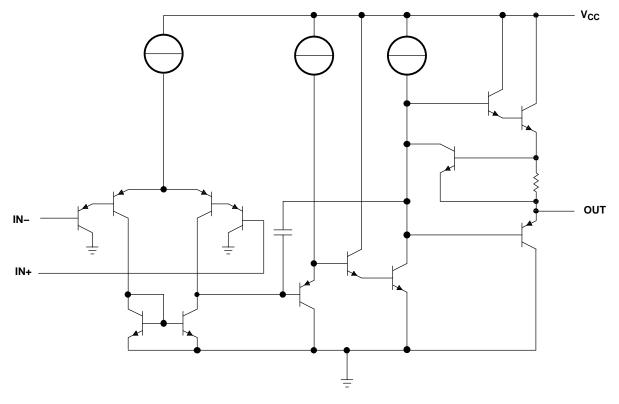
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



2

SLOS460A-MARCH 2005-REVISED MAY 2005

### SCHEMATIC (EACH AMPLIFIER)



## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |   |            | MIN       | MAX | UNIT |  |
|------------------|---|------------|-----------|-----|------|--|
| V <sub>CC</sub>  | Supply voltage range <sup>(2)</sup>                 |            | ±16 or 32 | V   |      |  |
| V <sub>ID</sub>  | Differential input voltage <sup>(3)</sup>           |            |           | ±32 | V    |  |
| VI               | Input voltage (either input)                        | -0.3       | 32        | V   |      |  |
|                  | Duration of output short circuit (one amplifier) to |            | Unlimited |     |      |  |
|                  |   | D package  |           | 86  |      |  |
| $\theta_{JA}$    | Package thermal impedance <sup>(5)(6)</sup>         | N package  |           | 80  | °C/W |  |
|                  |   | PW package |           | 113 |      |  |
| TJ               | Operating virtual junction temperature              |            | 150       | °C  |      |  |
| T <sub>stg</sub> | Storage temperature range                           |            | -65       | 150 | °C   |  |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values (except differential voltages and  $V_{CC}$  specified for the measurement of  $I_{OS}$ ) are with respect to the network GND.

(3) Differential voltages are at IN+, with respect to IN-.

(4) Short circuits from outputs to  $V_{CC}$  can cause excessive heating and eventual destruction.

- (5) Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.

#### (b) The package thermal impedance is calculated in accordance with JESD 51

### **ESD** Protection

| TEST CONDITIONS  | ТҮР | UNIT |
|------------------|-----|------|
| Human-Body Model | ±2  | kV   |

#### SLOS460A-MARCH 2005-REVISED MAY 2005

## **Electrical Characteristics**

 $\rm T_{A}$  = 25°C,  $\rm V_{CC}$  = 5 V,  $\rm V_{IC}$  =  $\rm V_{CC}/2, \, R_{L}$  = 100 k $\Omega$  to GND (unless otherwise noted)

| PARAMETER                      |                               | TEST CONDITIONS <sup>(1)</sup>                  | T <sub>A</sub> (2) | L                     | .P324              |     | LI                    | P2902              |     | UNIT  |  |
|--------------------------------|-------------------------------|---|--------------------|-----------------------|--------------------|-----|-----------------------|--------------------|-----|-------|--|
|                                |                               | TEST CONDITIONS                                 | 'A'-'              | MIN                   | TYP <sup>(3)</sup> | MAX | MIN                   | TYP <sup>(3)</sup> | MAX | UNIT  |  |
|                                | lanut offentueltere           |   | 25°C               |                       | 2                  | 4   |                       | 2                  | 4   |       |  |
| V <sub>IO</sub>                | Input offset voltage          |   | Full range         |                       |                    | 9   |                       |                    | 10  | mV    |  |
|                                | lanut bing sumant             |   | 25°C               |                       | 2                  | 10  |                       | 2                  | 20  | 0     |  |
| I <sub>IB</sub>                | Input bias current            |   | Full range         |                       |                    | 20  |                       |                    | 40  | nA    |  |
|                                | have the first summer t       |   | 25°C               |                       | 0.2                | 2   |                       | 0.5                | 4   |       |  |
| I <sub>IO</sub>                | Input offset current          |   | Full range         |                       |                    | 4   |                       |                    | 8   | nA    |  |
| •                              | Large-signal                  | $R_{I} = 10 k\Omega$ to GND,                    | 25°C               | 50                    | 100                |     | 40                    | 70                 |     | \//\/ |  |
| A <sub>V</sub>                 | voltage gain                  | $V_{CC}^{L} = 30 V$                             | Full range         | 40                    |                    |     | 30                    |                    |     | V/mV  |  |
|                                | Common-mode                   | $V_{CC} = 30 V_{,}$                             | 25°C               | 80                    | 90                 |     | 80                    | 90                 |     |       |  |
| CMRR                           | CMRR rejection ratio          | $V_{IC} = 0 V \text{ to } V_{CC} - 1.5 V$       | Full range         | 75                    |                    |     | 75                    |                    |     | dB    |  |
|                                | Power-supply                  |   | 25°C               | 80                    | 90                 |     | 80                    | 90                 |     |       |  |
| k <sub>VSR</sub>               | rejection ratio               | $V_{CC} = 5 V \text{ to } 30 V$                 | Full range         | 75                    |                    |     | 75                    |                    |     | V     |  |
| I <sub>CC</sub> Supply current | <u>_</u>                      | 25°C  |                    | 85                    | 150                |     | 85                    | 150                |     |       |  |
|                                | R <sub>L</sub> = ∞            | Full range                                      |                    |                       | 250                |     |                       | 275                | μA  |       |  |
|                                | Output voltage                | $I_1 = 0.35 \text{ mA to GND},$                 | 25°C               | 3.4                   | 3.6                |     | 3.4                   | 3.6                |     | v     |  |
| V <sub>OH</sub>                | swing (high)                  | $V_{IC} = 0 V$                                  | Full range         | V <sub>CC</sub> – 1.9 |                    |     | V <sub>CC</sub> – 1.9 |                    |     |       |  |
| .,                             | Output voltage                | $I_L = 0.35 \text{ mA from } V_{CC},$           | 25°C               | 0.82                  | 0.7                |     | 0.82                  | 0.7                |     |       |  |
| V <sub>OL</sub>                | swing (low)                   | $V_{IC} = 0 V$                                  | Full range         | 1                     |                    |     | 1                     |                    |     | V     |  |
|                                | Output source                 |   | 25°C               | 7                     | 10                 |     | 7                     | 10                 |     |       |  |
| I <sub>O</sub>                 | current                       | $V_{O} = 3 V, V_{ID} = 1 V$                     | Full range         | 4                     |                    |     | 4                     |                    |     | mA    |  |
|                                |                               |   | 25°C               | 4                     | 5                  |     | 4                     | 5                  |     |       |  |
|                                |                               | $V_{O} = 1.5 V, V_{ID} = -1 V$                  | Full range         | 3                     |                    |     | 3                     |                    |     |       |  |
| I <sub>O</sub>                 | Output sink current           | $V_{O} = 1.5 \text{ V}, V_{ID} = -1 \text{ V},$ | 25°C               | 2                     | 4                  |     | 2                     | 4                  |     | mA    |  |
|                                |                               | $V_{IC} = 0 V$                                  | Full range         | 1                     |                    |     | 1                     |                    |     |       |  |
|                                |                               |   | 25°C               |                       | 20                 | 35  |                       | 20                 | 35  |       |  |
| I <sub>OS,GND</sub>            | Output short to GND           | $V_{ID} = 1 V$                                  | Full range         |                       |                    | 40  |                       |                    | 40  | mA    |  |
|                                | Output shart to M             |   | 25°C               |                       | 15                 | 30  |                       | 15                 | 30  |       |  |
| los,vcc                        | Output short to $V_{CC}$      | $V_{ID} = -1 V$                                 | Full range         |                       |                    | 45  |                       |                    | 45  | mA    |  |
| ∝V <sub>IO</sub>               | Input offset<br>voltage drift |   | 25°C               |                       | 10                 |     |                       | 10                 |     | μV/°C |  |
| ∝I <sub>IO</sub>               | Input offset<br>current drift |   | 25°C               |                       | 10                 |     |                       | 10                 |     | pA/∘C |  |

For full-range temperature limits: V<sub>CC</sub> = 3 V to 32 V, V<sub>ICR</sub> = 0 V to V<sub>CC</sub> − 1.5 V (unless otherwise noted)
 Full range is 0°C to 70°C for LP324 and −40°C to 85°C for LP2902.
 All typical values are at T<sub>A</sub> = 25°C.

### **Operating Conditions**

 $V_{CC} = \pm 15 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}$ 

|     | PARAMETER              |     |      |  |  |  |
|-----|------------------------|-----|------|--|--|--|
| GBW | Gain bandwidth product | 100 | kHz  |  |  |  |
| SR  | Slew rate              | 50  | V/ms |  |  |  |



## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| LP2902D          | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LP2902                  | Samples |
| LP2902DR         | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LP2902                  | Samples |
| LP2902N          | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -40 to 85    | LP2902N                 | Samples |
| LP2902PW         | ACTIVE        | TSSOP        | PW                 | 14   | 90             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LP2902                  | Samples |
| LP2902PWR        | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LP2902                  | Samples |
| LP2902PWRE4      | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LP2902                  | Samples |
| LP324D           | ACTIVE        | SOIC         | D                  | 14   | 50             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | LP324                   | Samples |
| LP324DR          | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU   SN                          | Level-1-260C-UNLIM   | 0 to 70      | LP324                   | Samples |
| LP324DRG4        | ACTIVE        | SOIC         | D                  | 14   | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | LP324                   | Samples |
| LP324N           | ACTIVE        | PDIP         | N                  | 14   | 25             | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | 0 to 70      | LP324N                  | Samples |
| LP324PW          | ACTIVE        | TSSOP        | PW                 | 14   | 90             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | LP324                   | Samples |
| LP324PWR         | ACTIVE        | TSSOP        | PW                 | 14   | 2000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | LP324                   | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.



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# PACKAGE OPTION ADDENDUM

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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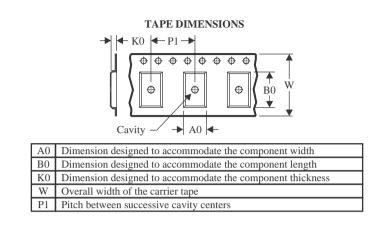


Texas

STRUMENTS

### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| LP2902DR                    | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| LP2902PWR                   | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| LP324DR                     | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.8                     | 6.5        | 9.5        | 2.1        | 8.0        | 16.0      | Q1               |
| LP324DR                     | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| LP324DRG4                   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| LP324PWR                    | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |



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# PACKAGE MATERIALS INFORMATION

3-Jun-2022



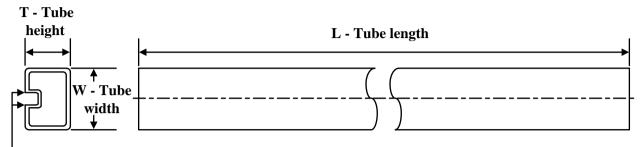
| Device    | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------|--------------|-----------------|------|------|-------------|------------|-------------|
| LP2902DR  | SOIC         | D               | 14   | 2500 | 340.5       | 336.1      | 32.0        |
| LP2902PWR | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| LP324DR   | SOIC         | D               | 14   | 2500 | 364.0       | 364.0      | 27.0        |
| LP324DR   | SOIC         | D               | 14   | 2500 | 340.5       | 336.1      | 32.0        |
| LP324DRG4 | SOIC         | D               | 14   | 2500 | 340.5       | 336.1      | 32.0        |
| LP324PWR  | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |

# TEXAS INSTRUMENTS

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# TUBE



# - B - Alignment groove width

### \*All dimensions are nominal

| Device   | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|----------|--------------|--------------|------|-----|--------|--------|--------|--------|
| LP2902D  | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| LP2902N  | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| LP2902PW | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| LP324D   | D            | SOIC         | 14   | 50  | 507    | 8      | 3940   | 4.32   |
| LP324N   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| LP324PW  | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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